

SCN8032AH/SCN8052AH

Single-Chip 8-Bit Microcontroller

Product Specification

Microprocessor Division

DESCRIPTION

The Signetics SCN8032AH/SCN8052AH is a high-performance microcontroller fabricated using the Signetics highly reliable +5V, depletion-load, N-channel, silicon-gate, N500 MOS process technology. It provides the hardware features, architectural enhancements and instructions that are necessary to make it a powerful and cost-effective controller for applications requiring up to 64K bytes of programming memory and up to 64K bytes of data storage.

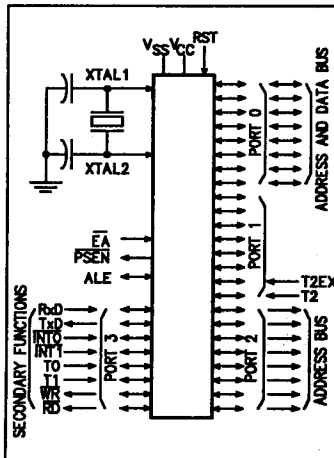
The SCN8032AH contains 256 bytes of read/write data memory, 32 I/O lines configured as four 8-bit ports, three 16-bit timer/counters, a six-source two-priority-level nested interrupt structure, a programmable serial I/O port and an on-chip oscillator and clock circuitry. The SCN8052AH has all of these features plus 8K bytes of non-volatile read-only program memory. Both microcontrollers have memory expansion capabilities of up to 64K bytes of data storage and 64K bytes of program memory that may be realized with standard TTL compatible memories.

Because of its extensive BCD/binary arithmetic and bit-handling facilities, the SCN8032AH/SCN8052AH microcontroller is efficient at both computational and control-oriented tasks. Efficient use of program memory is also achieved by using the familiar compact instruction set of the 8031/8051. Forty-four percent of the instructions are one-byte, 41% two-byte, and 15% three-byte instructions. With a 12MHz crystal, the majority of the instructions execute in just 1.0µs. The longest instructions, multiply and divide, require only 4µs at 12MHz.

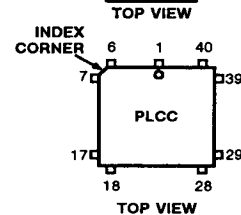
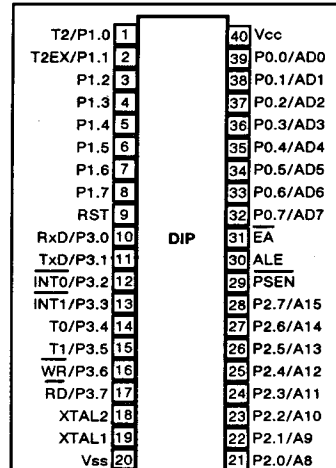
FEATURES

- SCN8032AH — control-oriented CPU with RAM and I/O
- SCN8052AH — an SCN8032AH with factory mask-programmable ROM
- 8K X 8 ROM (SCN8052AH only)
- 256 X 8 RAM
- 32 I/O lines (four 8-bit ports)
- Three 16-bit timer/counters
- Programmable full-duplex serial channel
 - Variable transmit/receive baud rate capability
- Timer 2 capture capability
- External memory addressing
 - 64K ROM and 64K RAM
- Boolean processor
- 128 user bit-addressable locations
- Upward compatible with SCN8031AH/SCN8051AH

LOGIC SYMBOL



PIN CONFIGURATION

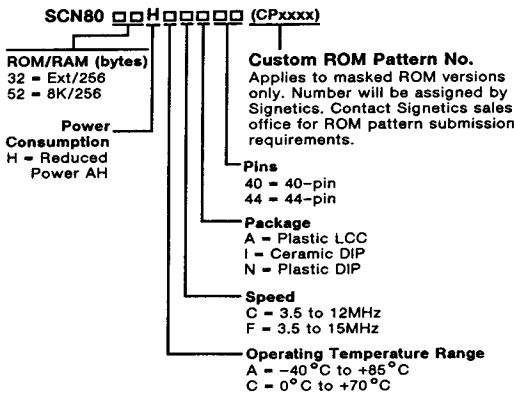


Pin	Function	Pin	Function
1	NC	23	NC
2	T2/P1.0	24	P2.0/A8
3	T2EX/P1.1	25	P2.1/A9
4	P1.2	26	P2.2/A10
5	P1.3	27	P2.3/A11
6	P1.4	28	P2.4/A12
7	P1.5	29	P2.5/A13
8	P1.6	30	P2.6/A14
9	P1.7	31	P2.7/A15
10	RST	32	PSEN
11	RxD/P3.0	33	ALE
12	NC	34	NC
13	TxD/P3.1	35	EA
14	INT0/P3.2	36	P0.7/AD7
15	INT1/P3.3	37	P0.6/AD6
16	T0/P3.4	38	P0.5/AD5
17	T1/P3.5	39	P0.4/AD4
18	WR/P3.6	40	P0.3/AD3
19	RD/P3.7	41	P0.2/AD2
20	XTAL2	42	P0.1/AD1
21	XTAL1	43	P0.0/AD0
22	Vss	44	Vcc

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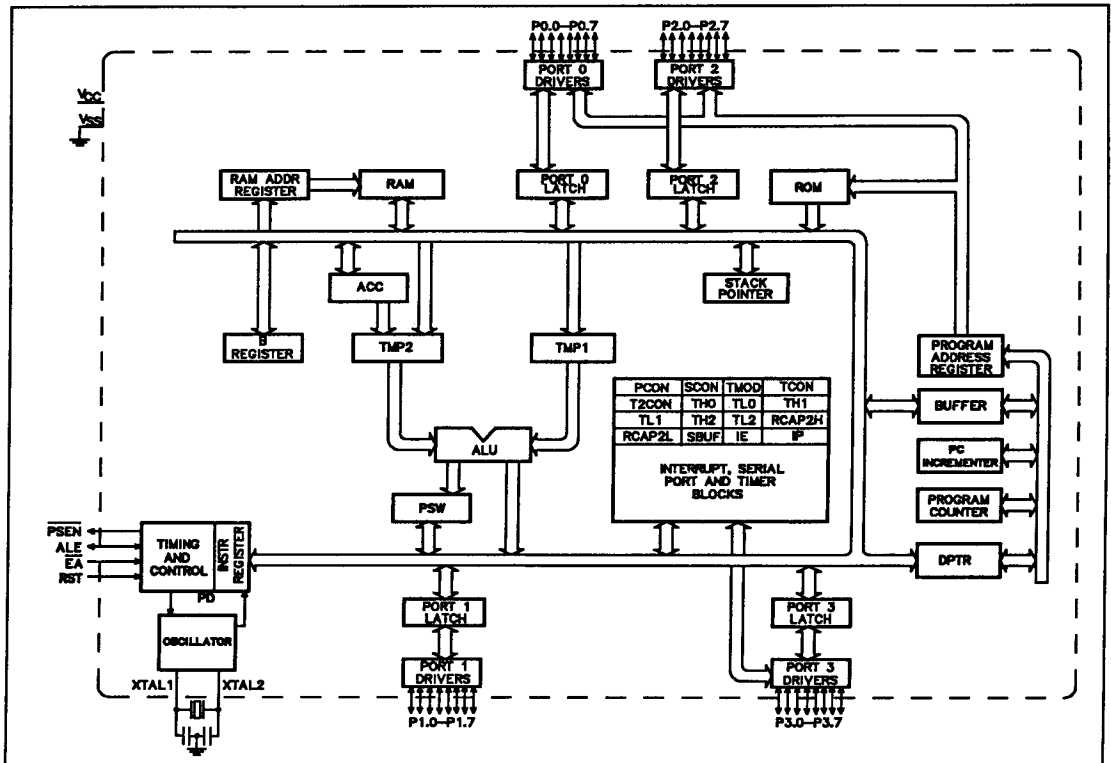
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ORDERING INFORMATION



PART NUMBER SELECTION			
ROMless	ROM	Temperature and Package	Frequency
SCN8032HCCN40	SCN8052HCCN40	0 to +70°C, plastic DIP	3.5 to 12MHz
SCN8032HCCA44	SCN8052HCCA44	0 to +70°C, plastic LCC	3.5 to 12MHz
SCN8032HACN40	SCN8052HACN40	-40 to +85°C, plastic DIP	3.5 to 12MHz
SCN8032HACA44	SCN8052HACA44	-40 to +85°C, plastic LCC	3.5 to 12MHz
SCN8032HCFN40	SCN8052HCFN40	0 to +70°C, plastic DIP	3.5 to 15MHz
SCN8032HCFA44	SCN8052HCFA44	0 to +70°C, plastic LCC	3.5 to 15MHz
SCN8032HAFN40	SCN8052HAFN40	-40 to +85°C, plastic PLCC	3.5 to 15MHz
SCN8032HAFA44	SCN8052HAFA44	-40 to +85°C, plastic PLCC	3.5 to 15MHz

BLOCK DIAGRAM



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PIN DESCRIPTION

MNEMONIC	PIN NO.		TYPE	NAME AND FUNCTION
	DIP	LCC		
V _{SS}	20	22	I	Ground: 0V reference.
V _{CC}	40	44	I	Power Supply: This is the power supply voltage for normal operation.
P0.0–P0.7	39–32	43–36	I/O	Port 0: Port 0 is an open-drain, bidirectional I/O port. Port 0 is also the multiplexed low-order address and data bus during accesses to external program and data memory. In this application, it uses strong internal pullups when emitting 1s. Port 0 also outputs the code bytes during program verification.
P1.0–P1.7	1–8	2–9	I/O	Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pull-ups. Pins P1.0 and P1.1 also correspond to the special functions T2, timer 2 counter trigger input, and T2EX, external input to timer 2. The output latch on these two special functions must be programmed to one for that function to operate. Port 1 also receives the low-order address byte during program verification.
	1	2	I	T2 (P1.0): Timer/counter 2 trigger input.
	2	3	I	T2EX (P1.1): Timer/counter 2 external count input.
P2.0–P2.7	21–28	24–31	I/O	Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). During accesses to external data memory that use 8-bit addresses (MOVX @Ri), port 2 emits the contents of the P2 special function register.
P3.0–P3.7	10–17	11, 13–19	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pullups. Port 3 is also used for the special features listed below:
	10	11	I	RxD (P3.0): Serial input port
	11	13	O	TxD (P3.1): Serial output port
	12	14	I	INT0 (P3.2): External interrupt
	13	15	I	INT1 (P3.3): External interrupt
	14	16	I	T0 (P3.4): Timer 0 external input
	15	17	I	T1 (P3.5): Timer 1 external input
	16	18	O	WR (P3.6): External data memory write strobe
	17	19	O	RD (P3.7): External data memory read strobe
RST	9	10	I	Reset: A high on this pin for two machine cycles while the oscillator is running, resets the device. A small external pull-down resistor ($\cong 8.2K\Omega$) from RST to V _{SS} permits power-on reset when a capacitor ($\cong 10\mu\text{f}$) is also connected from this pin to V _{CC} .
ALE	30	33	I/O	Address Latch Enable: Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory.
$\overline{\text{PSEN}}$	29	32	O	Program Store Enable: The read strobe to external program memory. When the device is executing code from external program memory, $\overline{\text{PSEN}}$ is activated twice each machine cycle, except that two $\overline{\text{PSEN}}$ activations are skipped during each access to external data memory. $\overline{\text{PSEN}}$ is not activated during fetches from internal program memory.
$\overline{\text{EA}}$	31	35	I	External Access Enable: $\overline{\text{EA}}$ must be externally held low to enable the device to fetch code from external program memory locations 0000H and 1FFFH. If EA is held high, the device executes from internal program memory unless the program counter contains an address greater than 1FFFH.
XTAL1	19	21	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL2	18	20	O	Crystal 2: Output from the inverting oscillator amplifier.

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OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator, as shown in the logic symbol, page 1.

To drive the device from an external clock source, XTAL2 should be driven while XTAL1 should be grounded. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

RESET

A reset is accomplished by holding the RST pin high for at least two machine cycles (24 oscillator periods), while the oscillator is running.

ABSOLUTE MAXIMUM RATINGS^{1, 2, 3}

PARAMETER	RATING	UNIT
Storage temperature range	-65 to +150	°C
All voltages with respect to ground	-0.5 to +7.0	V
Power dissipation	2.0	W

DC ELECTRICAL CHARACTERISTICS T_A = 0°C to +70°C, V_{CC} = 5V ±10%, V_{SS} = 0V^{4, 5}

Symbol	Parameter	Test Conditions	Limits		Unit
			Min	Max	
V _{IL}	Input low voltage		-0.5	0.8	V
V _{IH}	Input high voltage, except RST and XTAL2		2	V _{CC} +0.5	V
V _{IH1}	Input high voltage to RST for reset, XTAL2	XTAL1 to V _{SS}	2.5	V _{CC} +0.5	V
V _{OL}	Output low voltage, ports 1, 2, 3 ⁶	I _{OL} = 1.6mA		0.45	V
V _{OL1}	Output low voltage, port 0, ALE, PSEN ⁶	I _{OL} = 3.2mA		0.45	V
V _{OH}	Output high voltage, ports 1, 2, 3	I _{OH} = -80µA	2.4		V
V _{OH1}	Output high voltage port 0 in external bus mode, ALE, PSEN ³	I _{OH} = -400µA	2.4		V
I _{IL}	Logical 0 input current, ports 1, 2, 3	V _{IN} = 0.45V		-800	µA
I _{IH1}	Input high current to RST for reset	V _{IN} = V _{CC} - 1.5V		500	µA
I _{LI}	Input leakage current, port 0, EA	0.45 < V _{IN} < V _{CC}		±10	µA
I _{IL2}	Logical 0 input current for XTAL2	XTAL1 = V _{SS} , V _{IN} = 0.45V		-3.2	mA
I _{CC}	Power supply current	All outputs disconnected and EA = V _{CC}		175	mA
C _{IO}	Pin capacitance	f _C = 1MHz, T _A = 25°C		10	pF

T_A = -40°C to +85°C - Extended temperature range - SCN8052HAC only

V _{IH}	Input high voltage, except RST and XTAL2		2.2	V _{CC} +0.5	V
V _{IH1}	Input high voltage to RST for reset, XTAL2	XTAL1 to V _{SS}	2.7		V
I _{CC}	Power supply current	All outputs disconnected and EA = V _{CC}		175	mA

NOTES:

- Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the AC and DC Electrical Characteristics section of this specification is not implied.
- For operating at elevated temperatures, the device must be derated based on +150°C maximum junction temperature.
- This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying voltages greater than the rated maxima.
- Parameters are valid over operating temperature range unless otherwise specified.
- All voltage measurements are referenced to ground. For testing, all input signals swing between 0.45V and 2.4V with a transition time of 20ns maximum. All time measurements are referenced at input voltages of 0.8V and 2.0V and at output voltages of 0.8V and 2.0V as appropriate.
- VOL is degraded when the device rapidly discharges external capacitance. This AC noise is most pronounced during emission of address data. When using external memory, locate the latch or buffer as close to the device as possible.

Datum
Address
Write Data

Emitting
Ports
P2, P0
P0

Degraded
I/O Lines
P1, P3
P1, P3, ALE

VOL (Peak Max)
0.8V
0.8V

- CL = 100pF for port 0, ALE and PSEN outputs; CL = 80pF for all other ports.

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AC ELECTRICAL CHARACTERISTICS $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ or -40°C to $+85^\circ\text{C}$, $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}^1, 2$

SYMBOL	FIGURE	PARAMETER	12MHz CLOCK		VARIABLE CLOCK		UNIT
			Min	Max	Min	Max	
Program Memory							
t_{CLCL}		Oscillator frequency: Speed Versions SCN8052 C SCN8052 F			3.5 3.5	12 15	MHz MHz
t_{LHLL}	1	ALE pulse width	127		$2t_{\text{CLCL}}-40$		ns
t_{AVLL}	1	Address valid to ALE low	43		$t_{\text{CLCL}}-40$		ns
t_{LLAX}	1	Address hold after ALE low	48		$t_{\text{CLCL}}-35$		ns
t_{LLIV}	1	ALE low to valid instruction in		233		$4t_{\text{CLCL}}-100$	ns
t_{LLPL}	1	ALE low to PSEN low	58		$t_{\text{CLCL}}-25$		ns
t_{PLPH}	1	PSEN pulse width	215		$3t_{\text{CLCL}}-35$		ns
t_{PLIV}	1	PSEN low to valid instruction in		125		$3t_{\text{CLCL}}-125$	ns
t_{PXIX}	1	Input instruction hold after PSEN	0		0		ns
t_{PXIZ}	1	Input instruction float after PSEN		63		$t_{\text{CLCL}}-20$	ns
t_{AVIV}	1	Address to valid instruction in		302		$5t_{\text{CLCL}}-115$	ns
t_{PLAZ}	1	PSEN low to address float		20		20	ns
t_{PXAV}	1	PSEN to address valid	75		$t_{\text{CLCL}}-8$		ns
Data Memory							
t_{RLRH}	2	RD pulse width	400		$6t_{\text{CLCL}}-100$		ns
t_{WLWH}	3	WR pulse width	400		$6t_{\text{CLCL}}-100$		ns
t_{RLDV}	2	RD low to valid data in		252		$5t_{\text{CLCL}}-165$	ns
t_{RHDX}	2	Data hold after RD	0		0		ns
t_{RHDX}	2	Data float after RD		97		$2t_{\text{CLCL}}-70$	ns
t_{LLDV}	2	ALE low to valid data in		517		$8t_{\text{CLCL}}-150$	ns
t_{AVDV}	2	Address to valid data in		585		$9t_{\text{CLCL}}-165$	ns
t_{LLWL}	2, 3	ALE low to RD or WR low	200	300	$3t_{\text{CLCL}}-50$	$3t_{\text{CLCL}}+50$	ns
t_{AVWL}	2, 3	Address valid to WR low or RD low	203		$4t_{\text{CLCL}}-130$		ns
t_{QVWX}	3	Data valid to WR transition	23		$t_{\text{CLCL}}-60$		ns
t_{QVWH}	3	Data valid to WR high	433		$7t_{\text{CLCL}}-150$		ns
t_{WHQX}	3	Data hold after WR	33		$t_{\text{CLCL}}-8$		ns
t_{RLAZ}	2	RD low to address float		20		20	ns
t_{WHLH}	2, 3	RD or WR high to ALE high	43	123	$t_{\text{CLCL}}-40$	$t_{\text{CLCL}}+40$	ns
External Clock							
t_{CHCX}	5	High time			20		ns
t_{CLCX}	5	Low time			20		ns
t_{CLCH}	5	Rise time				20	ns
t_{CHCL}	5	Fall time				20	ns
Shift Register							
t_{XLXL}	4	Serial port clock cycle time	1.0		$12t_{\text{CLCL}}$		μs
t_{QVXH}	4	Output data setup to clock rising edge	700		$10t_{\text{CLCL}}-133$		ns
t_{XHGX}	4	Output data hold after clock rising edge	50		$2t_{\text{CLCL}}-117$		ns
t_{XHDX}	4	Input data hold after clock rising edge	0		0		ns
t_{XHDV}	4	Clock rising edge to input data valid		700		$10t_{\text{CLCL}}-133$	ns

NOTES:

- Parameters are valid over operating temperature range unless otherwise specified.
- Load capacitance for port 0, ALE, and PSEN = 100pF, load capacitance for all other outputs = 80pF.

EXPLANATION OF THE AC SYMBOLS

Each timing symbol has five characters. The first character is always 't' (= time). The other characters, depending on their positions, indicate the name of a signal or the logical status of that signal. The designations are:

- A - Address
- C - Clock
- D - Input data
- H - Logic level high
- I - Instruction (program memory contents)
- L - Logic level low, or ALE

- P - PSEN
- Q - Output data
- R - RD signal
- t - Time
- V - Valid
- W - WR signal
- X - No longer a valid logic level
- Z - Float

Examples: t_{AVLL} - Time for address valid to ALE low.
 t_{LLPL} - Time for ALE low to PSEN low.

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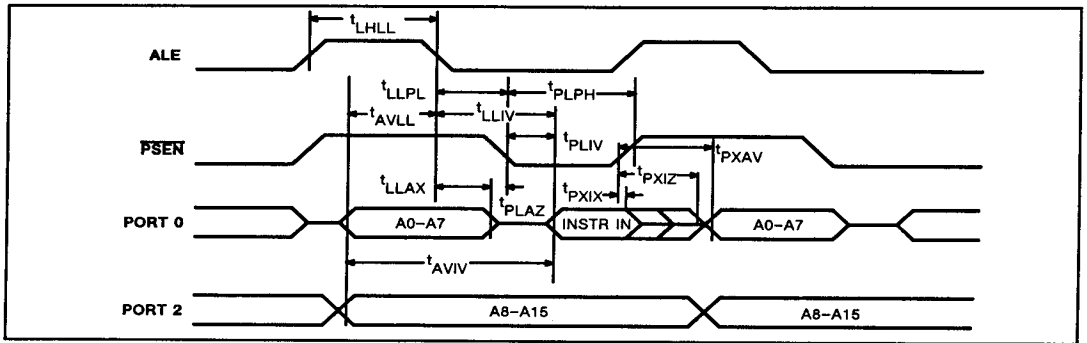


Figure 1. External Program Memory Read Cycle

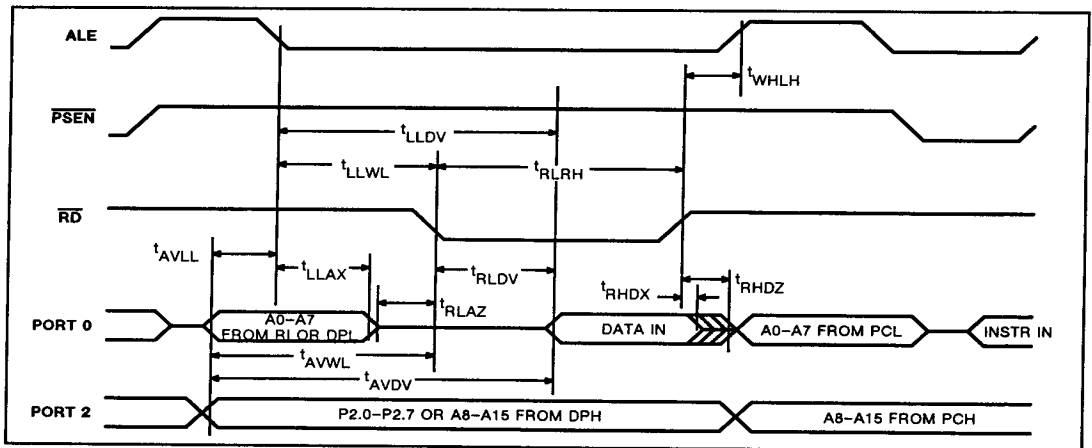


Figure 2. External Data Memory Read Cycle

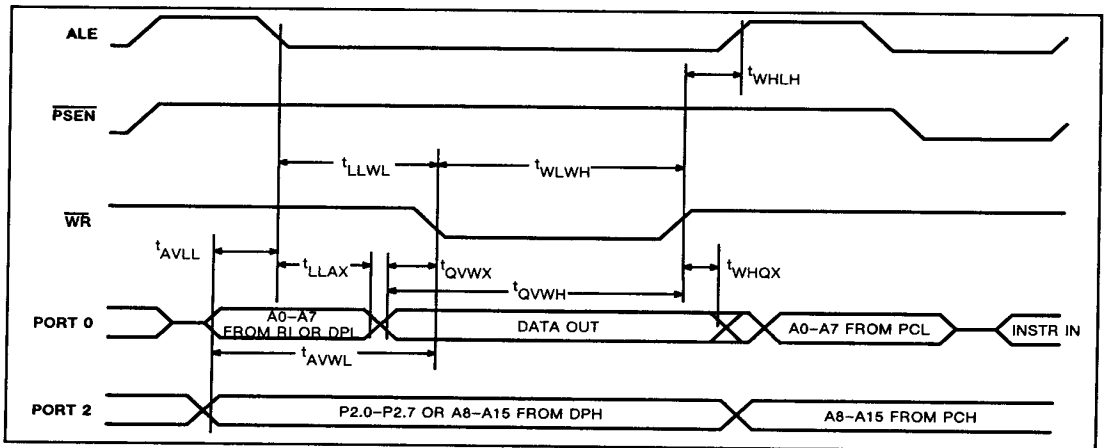


Figure 3. External Data Memory Write Cycle

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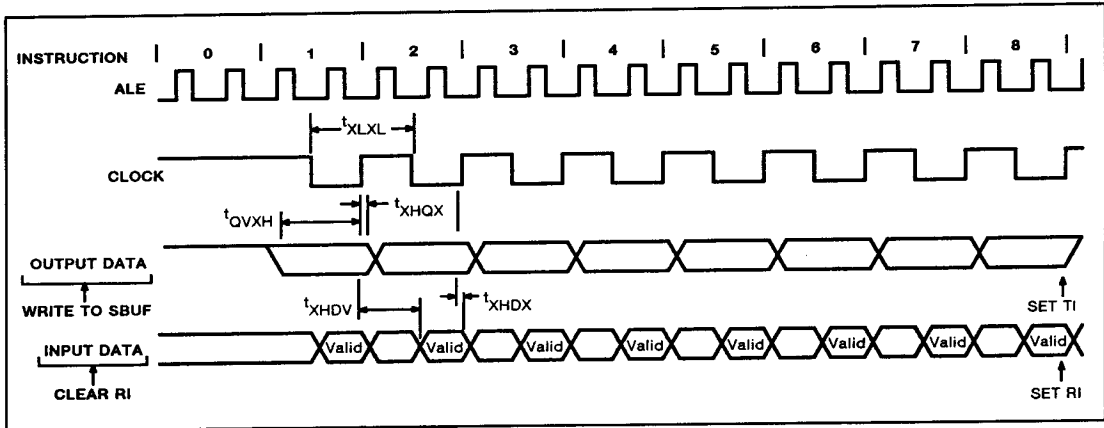


Figure 4. Shift Register Mode Timing

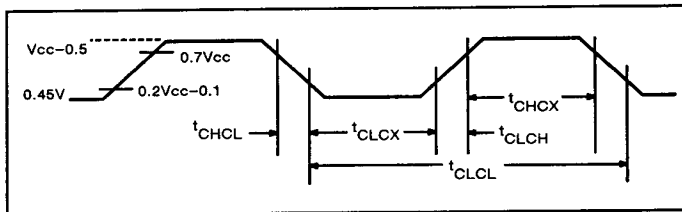


Figure 5. External Clock Drive

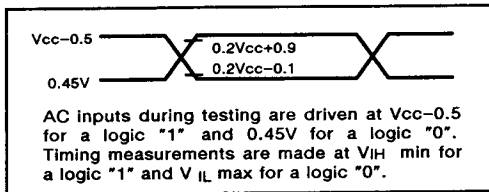


Figure 6. AC Testing Input/Output

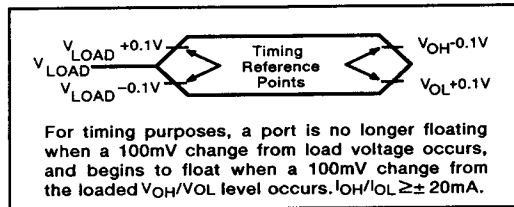


Figure 7. Float Waveform